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U.S. PTO 12/654615 12/24/2009

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ON FORM COVER SHEET

To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.	
1. Name of conveying party(les):	2. Name and address of receiving party(ies)
Nobukazu Mikami (11/26/2009), Hiroki Usui (11/26/2009), and Takuya Nakauchi (11/26/2009)	Name: Sony Corporation
Additional name(s) of conveying party(ies) attached?	Internal Address: Street Address:
3. Nature of conveyance/Execution Date(s):  Execution Date(s): in parentheses after inventor name  X Assignment Merger Change of Name  Security Agreement Joint Research Agreement  Government Interest Assignment  Executive Order 9424, Confirmatory License  Other	1-7-1 Konan Minato-Ku, Tokyo 108-0075 JAPAN  City: State: Country: Zip: Additional name(s) & address(es) Yes X No
	attached?
4. Application or patent number(s):  A. Patent Application No.(s)  This application  [26545]	his document is being filed together with a new application.  B. Patent No.(s)
Additional numbers attached?	Yes X No
5. Name and address to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved:
Name: Christopher M. Tobin RADER, FISHMAN & GRAUER PLLC	7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00
Internal Address: Atty. Dkt.: SON-4379 Street Address: 1233 20th Street, N.W. Suite 501	X Authorized to be charged to deposit account  Enclosed  None required (government interest not affecting title)
City: Washington	8. Payment Information
State:         DC         zip:         20036           Phone Number:         (202) 955-3750           Fax Number:         (202) 955-3751           Email Address:         cmt@rader(ishman.com)	Deposit Account Number 18-0013 Authorized User Name Christopher M. Tobin
9. Signature:	December 24, 2009
Signature  Christopher M. Tobin - 40,290  Name of Person Signing	Total number of pages including cover sheet, attachments, and documents:

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U.S. DEPARTMENT OF COMMERCE

United States Patent and Trademark Office

Attorney Docket No. SON-4379 SONY Ref. No.: S10P0033US00

## <u>ASSIGNMENT</u>

WHEREAS, I, as below named inventors, residing at the addresses stated next to our names, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in

SEMICONDUCTOR INTEGRATED CIRCUIT

RECORDED: 12/24/2009

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address

AND WHEREAS, SONY CORPORATION, a Japanese corporation, with offices at 1-7-1 Konan, Minato-ku, Tokyo, Japan (hereinafte referred to as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, t and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficienc of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto th said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said applicatior including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto:

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further emuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

he spaces that follow: Serial Number:	, Filing Date:
his assignment executed on the dates indicated below.	
NOBUKAZU MIKAMI	
Name of first or sole inventor SAITAMA JAPAN	Execution date of U.S. Patent Application
Residence of First or sole inventor  Nobukazu Mikami  Signature of first or sole inventor	November 26, 2009  Date of this assignment
HIROKI USUI	
Name of second inventor KANAGAWA JAPAN	Execution date of U.S. Patent Application
Residence of second inventor	November 26, 2009
Signature of second inventor	Date of this assignment
TAKUYA NAKAUCHI	
Name of third inventor KANAGAWA JAPAN	Execution date of U.S. Patent Application
Residence of third inventor  Takuya Nakauchi	November 26, 2009
Signature of third inventor	Date of this assignment

PATENT REEL: 023742 FRAME: 0978